

## 400mA Low Dropout Linear Regulator with Voltage Detector Function

#### FEATURES

- Including MOSFET for V<sub>OUT1</sub>, LDO for V<sub>OUT2</sub>, voltage detector, and shutdown control
- Low Dropout Voltage of 550mV(Typ.) at 400mA Output Current (V<sub>OUT2</sub>).
- Guaranteed 700mA Output Current for  $V_{\text{OUT1}}$  and 400mA for  $V_{\text{OUT2}}.$
- Low Ground Current at  $120\mu A$ .
- 2% Accuracy Output Voltage of V<sub>OUT2</sub>.
- Current Limit Function.
- Built in Voltage Detector
- Shutdown Control for  $V_{OUT1}$  and  $V_{OUT2}$

#### APPLICATIONS

- Voltage Regulator for DVD-ROM and CD-ROM Drivers.
- Voltage Regulator for HDD and Floppy Drivers.
- Voltage Regulator for circuits with Stepping Motor or Servo Motor.

#### DESCRIPTION

The AIC1729 is a low dropout linear regulator with voltage detection function.

It can be divided into 4 main function blocks, including MOSFET for V<sub>OUT1</sub>, LDO for V<sub>OUT2</sub> ,voltage detector, and two shutdown controls.

Voltage detector can be use to detect Vcc. The detecting voltage of the voltage detector is from 3.0V to 4.6V with 0.1V step. And the output (DOUT) of detecting voltage for Vcc with delay time adjustment function to indicate  $V_{CC}$  low. User only adds one external capacitor to finish it. When  $V_{CC}$  pin is under the set detection voltage.  $D_{OUT}$  pin is logic low.

 $V_{OUT1}$  is controlled by SD1 pin. When SD1 is logic high, the internal MOSFET for  $V_{OUT1}$  will be switched off, vice versa.

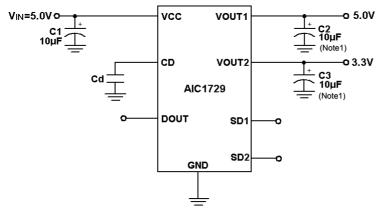
The LDO output voltage ( $V_{OUT2}$ ) is from 1.8V to 4.0V with 0.1V step for different application. It is also controlled by SD2 pin. When SD2 is logic high, the internal LDO for  $V_{OUT2}$  will be shutdown, vice versa.

The superior characteristics of the AIC1729 include very low dropout voltage, and 2% accuracy output voltage. Typical ground current remains 120  $\mu$  A, from no load to maximum loading conditions. Dropout voltage of V<sub>OUT2</sub> is 550mV at 400mA output current. Output current limiting is provided at V<sub>OUT1</sub> and V<sub>OUT2</sub>.

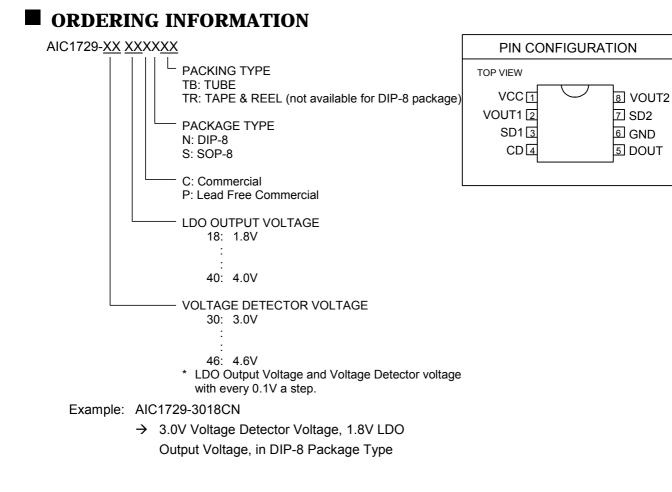
AIC1729 comes in the popular SO8 package.



#### **TYPICAL APPLICATION CIRCUIT**



Power Source for CD-drivers and DVD-drivers





#### ■ ABSOLUTE MAXIMUM RATINGS

Input Supply Voltage		-0.3~8V
Control Input (V <sub>CTL</sub> )		-0.3V ~7V
Operating Temperature Range		
Junction Temperature		
Storage Temperature Range		-65°C ∼ 150°C
Lead Temperature (Soldering, 10sec)		
Thermal Resistance, R <sub>JC</sub> (Junction to Case)	DIP-8	<u>60°C /W</u>
	SOP-8	
Thermal Resistance, R JA (Junction to Ambient)	DIP-8	
(Assume no Ambient Airflow, no heatsink)		160°C/W

Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

## ELECTRICAL CHARACTERISTICS (TA=25°C, VIN=5.0V, IOUT1=IOUT2=400mA, SD1=SD2=Low, unless otherwise specified.) (Note2)

PARAMETER	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Ground Current	I <sub>OUT1</sub> =0.1mA~700mA I <sub>OUT2</sub> =0.1mA~400mA V <sub>IN</sub> = 4.0V~8.0V		120	200	μΑ
Output Voltage Temperature Coefficiency	(Note 3)		100		PPM/°C
VOUT1					
Output MOSFET Resistance	V <sub>IN</sub> = 5.0V		370	450	mΩ
Current Limit(Note 4)		700	950		mA
Output Turn-on Rise Delay			100		μS
Output Turn-on Rise Time			1000		μS
	V <sub>SD</sub> =Logic"0"			0.8	v
SD1 Pin Voltage	V <sub>SD</sub> =Logic"1"	2.4			V
VOUT2(1.8V~4.0V with 0.1	V step)				
LDO Output Voltage	No Load	V <sub>SET</sub> × 0.98	$V_{\text{SET}}$	V <sub>SET</sub> × 1.02	V
Line Regulation	I <sub>L</sub> =1mA,V <sub>IN</sub> =4.0V~8.0V		3	10	mV
Load Regulation (Note 5)	V <sub>IN</sub> =5V,I <sub>L</sub> =0.1mA~400mA		50	90	mV
Current Limit (Note 4)		400	650		mA



#### ELECTRICAL CHARACTERISTICS (Continued)

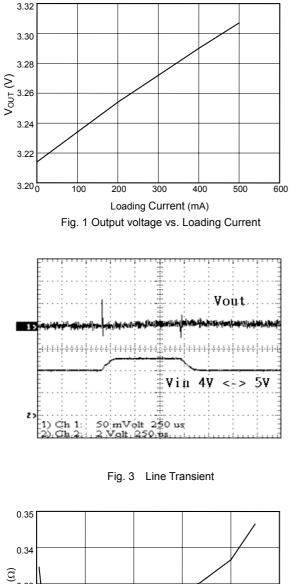
PARAMETER	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
	V <sub>OUT</sub> ≥3.3V	I <sub>L</sub> =100mA		140	200	-	
		I <sub>L</sub> =200mA		280	350		
		I <sub>L</sub> =300mA		420	500		
		I <sub>L</sub> =400mA		550	700		
		I <sub>L</sub> =100mA		250	300	mV	
Dropout Voltage		I <sub>L</sub> =200mA		420	500		
(Note 6)	2.5V ≤V <sub>OUT</sub> <3.3V	I <sub>L</sub> =300mA		600	700		
		I <sub>L</sub> =400mA		780	900		
		I <sub>L</sub> =100mA		700	800		
	V <sub>OUT</sub> < 2.5V	I <sub>L</sub> =200mA		880	950		
		I <sub>L</sub> =300mA		1050	1150		
		I <sub>L</sub> =400mA		1220	1400		
SD2 Pin Voltage	V <sub>SD</sub> =Logic"0"				0.8	V	
SDZ FIIT Voltage	V <sub>SD</sub> =Logic"1"		2.4			v	
Voltage Detector(3.0V ~ 4.6V with 0.1V step)							
Detect Voltage(V <sub>DET</sub> )			V <sub>DSET</sub> × 0.98	V <sub>DSET</sub>	V <sub>DSET</sub> × 1.02	V	
Detect Threshold Hysteresis				V <sub>DET</sub> × 1.05		V	
	When V <sub>DET</sub> is Detected				0.6	V	
V <sub>DOUT</sub>	When V <sub>DET</sub> is not Detected		1.65			v	
Delay Time	CD Pin Open			1	3	mS	

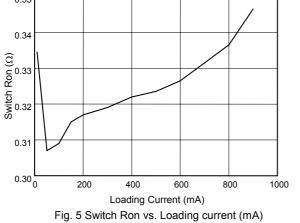
Note 1: To avoid output oscillation, aluminum electrolytic output capacitor is recommended and ceramic capacitor is not suggested.

- Note 2: Specifications are production tested at T<sub>A</sub>=25°C. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).
- Note 3: Guaranteed by design.
- Note 4: Current limit is measured by pulsing a short time.
- Note 5: Regulation is measured at constant junction temperature, using pulse testing with a low ON time.
- Note 6: Dropout voltage is defined as the input to output differential at which the output voltage drops 100mV below the value measured with a 1V differential.



### **TYPICAL PERFORMANCE CHARACTERISTICS**





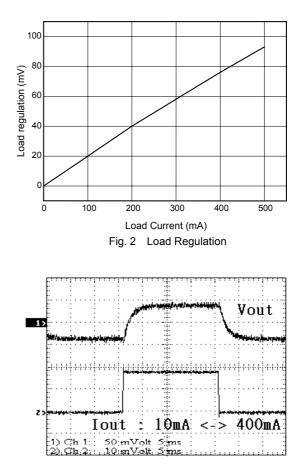
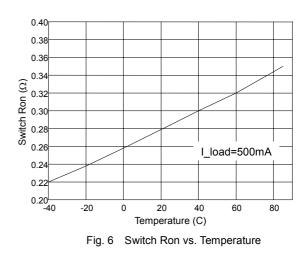


Fig. 4 Load Transient



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## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

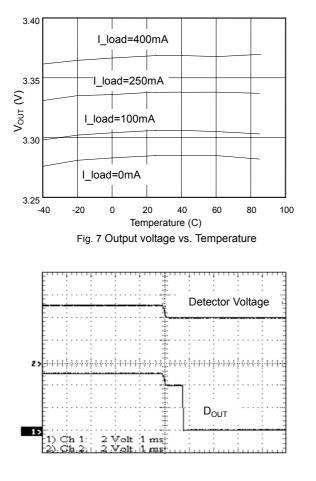


Fig. 9 Built-in Delay Time Waveform

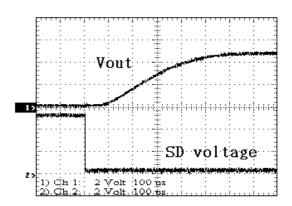
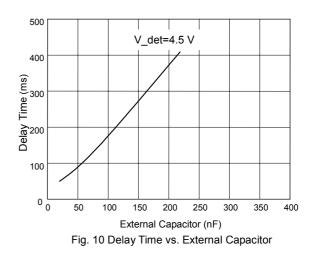
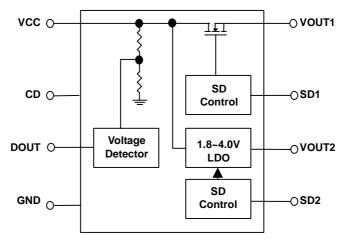


Fig. 8 Output Turn-on Rise Time



### **BLOCK DIAGRAM**





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#### **PIN DESCRIPTION**

- PIN 1: VCC- This pin is the main input supply for the IC, normally 5V
- PIN 2: VOUT1- This pin is the voltage output which is connected to Vcc directly via internal MOSFET switch, normally 5V
- PIN 3: SD1- VOUT1 shutdown pin. Logic high input for disabling the internal MOS Switch.

PIN 4: CD-	This pin is to determine delay	
	time by attaching a capacitor	
PIN 5: DOUT-	This pin is voltage detector	
	output, pulled low when V <sub>IN</sub>	
	detected	
PIN 6: GND-	IC ground pin	
PIN 7: SD2-	VOUT2 shutdown pin. Logic high	
	input for disabling LDO output.	

PIN 8: VOUT2- This pin is 3.3V LDO voltage output

#### **APPLICATION INFORMATION**

#### **INPUT-OUTPUT CAPACITORS**

Linear regulators require input and output capacitors to maintain stability. Input capacitor at  $10\mu F$  with  $10\mu F$  aluminum electrolytic output capacitor is recommended.

#### POWER DISSIPATION

The maximum power dissipation of AIC1729 depends on the thermal resistance of its case and circuit board, the temperature difference between the die junction and ambient air, and the rate of airflow. The rate of temperature rise is greatly affected by the mounting pad configuration on the PCB, the board material, and the ambient temperature. When the IC mounting with good thermal conductivity is used, the junction temperature will be low even when large power dissipation applies.

The power dissipation across the device is

$$\begin{split} P &= I_{OUT} \; (V_{IN} - V_{OUT}). \\ \text{The maximum power dissipation is:} \\ P_{MAX} &= \frac{(T_{J\text{-max}} - T_A)}{R\theta_{JA}} \end{split}$$

Where  $T_{J-max}$  is the maximum allowable junction temperature (125°C), and  $T_A$  is the ambient temperature suitable in application.

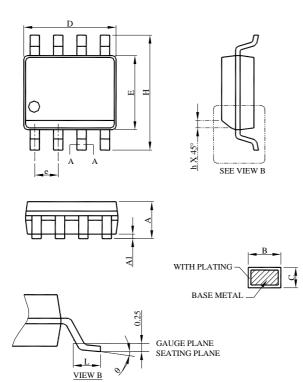
As a general rule, the lower temperature is, the better reliability of the device is. So the PCB mounting pad should provide maximum thermal conductivity to maintain low device temperature.

GND pin performs a dual function for providing an electrical connection to ground and channeling heat away. Therefore, connecting the GND pin to ground with a large pad or ground plane would increase the power dissipation and reduce the device temperature.



#### PHYSICAL DIMENSIONS (unit: mm)

#### • SOP-8



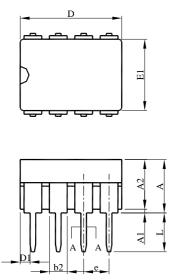
S Y	SOP-8		
M	MILLIMETERS		
B O L	MIN.	MAX.	
А	1.35	1.75	
A1	0.10	0.25	
В	0.33	0.51	
С	0.19	0.25	
D	4.80	5.00	
E	3.80	4.00	
е	1.27 BSC		
Н	5.80	6.20	
h	0.25	0.50	
L	0.40	1.27	
θ	0°	8°	

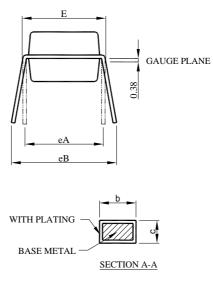
Note:

- 1.Refer to JEDEC MS-012AA.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 6 mil per side.
- 3.Dimension "E" does not include inter-lead flash or protrusions. Inter-lead flash or protrusion shall not exceed 10 mil per side. 4.Controlling dimension is millimeter, converted inch dimensions
- are not necessarily exact.



• DIP-8





s Y	DIP-8		
M B O	MILLIMETERS		
O L	MIN.	MAX.	
А		5.33	
A1	0.38		
A2	2.92	4.95	
b	0.36	0.56	
b2	1.14	1.78	
с	0.20	0.35	
D	9.01	10.16	
D1	0.13		
Е	7.62	8.26	
E1	6.10	7.11	
е	2.54 BSC		
eA	7.62 BSC		
eВ		10.92	
L	2.92	3.81	

Note:

- 1.Refer to JEDEC MS-001BA.
- 2.Dimension D, D1 and E1 do not include mold flash or
- protrusions. Mold flash or protrusion shall not exceed 10 mil. 3.Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

#### Note:

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